Difference between Shanghai and Hefei plants (5M+1E change point)



Appl No.3022002

Item	Shanghai Plant	Hefei Plant	Variation	Remarks	
	TO-252		variation	Remarks	
Name of production plant	GEM Electronics (Shanghai) Co.,Ltd.	GEM Electronics (Hefei) Co.,Ltd.	having	The production site was changed to another plant of GEM.	
The country of origin	China		None	The country of origin is the same in China.	
Man	Workers certified by the contractor		None	Education is conducted in the same program. No difference in competence.	
Material	Wafers are supplied by ROHM		None	Uses the same elements. No difference in elements.	
	Materials used by contractors		None	Use of identical assembly materials. (Manufacturer, part number, and production location are also identical)	
Machine	Use of contractor's equipment		None	The same manufacturer's machine is used. No difference with the production machine.	
Method	Contractor's work standards		None	Use the same work standards. No difference in production methods.	
Measurement	Measured with a program determined by ROHM		None	Use the same program/measuring device. No difference in measurement process.	
Environment	Production process clean room management Temperature: 20 to 28°C Humidity: 40-60% RH Clean room class: 10,000		None	The same management is implemented. No difference with respect to environment.	

[➤] Production equipment, materials, production method and education program used at the Hefei plant are identical to those used at the Shanghai plant. The only change is a change in production location.

Difference between Shanghai and Hefei Plants (Product Change Points)



Appl No.302200

Item	Shanghai Plant	Hefei Plant	Variation	Remarks
Item	TO-252		Variation	Nemains
Absolute maximum ratings	Identity (No difference)		None	For details, please refer to the individual datasheets.
Electrical Characteristics	Identity (No difference)		None	For details, please refer to the individual datasheets.
Dimensions	Identity (No difference)		None	For details, please refer to the individual datasheets.
Reference Land Pattern	Identity (No difference)		None	For details, please refer to the individual datasheets.
Terminal processing	Identity (Electroplating : Sn)		None	Generation method/material/thickness No difference.
Marking method	Identity (Scanning laser marking)		None	Printing method/size/font No difference.
Contents of Marking	Identity (No difference in description)		None	For details of the description, please refer to the Appendix of [Identification(Traceability)] section.
Packing	Identity (No difference in taping and packaging specifications)		None	For details, please refer to the individual datasheets.
Label	Identity (No difference in description)		None	For details of the description, please refer to the Appendix of [Identification(Traceability)] section.

> Product electrical Characteristics, specification and dimensions are same, there is no difference.

Identification (Traceability) of Shanghai and Hefei Plants



Item	Shanghai Plant	Hefei Plant	Variation	Remarks
100111	TO-252			Remarks
Marking	①: Indicate part number ②: Y=end of production year, WW=week of production. ③: XXX = Serial No.			The production plant can be identified by the marking (④ with or without dots). [Without dots: Made at Shanghai Plant], [With dots: Made at Hefei Plant]
Label (Lot No.)	2SCR573D3 TL1 F 2,500pcs 2137 0191EG 2SCR573D3 TL1 2110012 MADE IN CHINA ROHM SEMICONDUCTOR Lot No. end = EG Lot No. end = FG		having	The last two digits of the Lot No. can be used to identify the production plant. [EG: made in Shanghai plant] [FG: made in Hefei plant]. (Country of origin: China, no difference)